

L Number	Hits	Search Text	DB	Time stamp
7	1474	257/532.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:08
9	150	257/535.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:08
10	331	257/621.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:08
12	112	336/68.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:08
14	29	336/230.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:08
15	865	336/223.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:09
17	138	336/187.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:09
19	28217	inductor with capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:10
20	4109	(inductor with capacitor) and substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:11
22	2054	((inductor with capacitor) and substrate) and dielectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:11
23	376	((((inductor with capacitor) and substrate) and dielectric) and (substrate near5 (via or hole or trench or groove)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:29
24	162	(((((inductor with capacitor) and substrate) and dielectric) and (substrate near5 (via or hole or trench or groove)))) and (spiral or circular)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:30
6	433	257/531.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:46
8	237	257/534.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:58

25	281	257/528.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:02
26	1606	257/774.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:04
27	605	257/728.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:08
28	1391	257/724.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:09
11	890	336/65.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:20
13	352	336/225.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:21
16	167	336/186.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:22
29	70	438/957.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:25
30	105	438/329.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:25
-	624	336/65.ccls.	USPAT	2002/12/02 12:23
-	101	336/68.ccls.	USPAT	2002/12/02 12:23
-	248	336/225.ccls.	USPAT	2002/12/02 12:23
-	27	336/230.ccls.	USPAT	2002/12/02 12:23
-	784	336/223.ccls.	USPAT	2002/12/02 12:23
-	135	336/186.ccls.	USPAT	2002/12/02 12:23
-	124	336/187.ccls.	USPAT	2002/12/02 12:23
-	1873	336/65.ccls. or 336/68.ccls. or 336/225.ccls. or 336/230.ccls. or 336/223.ccls. or 336/186.ccls. or 336/187.ccls.	USPAT	2002/12/02 12:24
-	221	(336/65.ccls. or 336/68.ccls. or 336/225.ccls. or 336/230.ccls. or 336/223.ccls. or 336/186.ccls. or 336/187.ccls.) and inductor	USPAT	2002/12/02 12:24

L Number	Hits	Search Text	DB	Time stamp
32	151	(RF or (radio adj frequency)) and substrate and (dielectric near3 layer) and ((metal or conduct\$4) near3 (layer or film)) with (spiral or circular))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:46
-	1	("6322634").PN.	USPAT	2002/06/12 11:03
-	11106	RF and substrate and dielectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/04 10:56
-	14	(RF and substrate and dielectric) and (bias near4 feeding)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/04 10:55
-	4002	(RF or (radio adj frequency)) and substrate and (dielectric near3 layer) and ((metal or conduct\$4) near3 (layer or film))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/10 17:39
-	3346	((RF or (radio adj frequency)) and substrate and (dielectric near3 layer) and ((metal or conduct\$4) near3 (layer or film))) and (spiral or circ\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/04 11:03
-	1	"5541442".PN.	USPAT	2002/06/04 14:39
-	1	"5446311".PN.	USPAT	2002/06/04 14:41
-	1	"5095357".PN.	USPAT	2002/06/04 14:42
-	1	"5384274".PN.	USPAT	2002/06/04 17:23
-	1	"5268315".PN.	USPAT	2002/06/04 17:23
-	1	"5174012".PN.	USPAT	2002/06/04 17:23
-	1	"5753949".PN.	USPAT	2002/06/05 11:02
-	1	"5583359".PN.	USPAT	2002/06/05 11:02
-	307	(RF or (radio adj frequency)) and substrate and (dielectric) and ((metal or conduct\$4) same ((via or feedthrough) and inductor))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/10 17:43
-	473	257/531	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/11 13:50
-	1667	257/532	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/11 13:01
-	221	257/534	USPAT	2002/06/12 11:04
-	206	257/535	USPAT	2002/06/12 11:04
-	265	257/621	USPAT	2002/06/12 11:04

IS&R 1 ("6322634").PN.
BRS 11106 RF and substrate and dielectric
BRS 14 (RF and substrate and dielectric) and (bias near4 feeding)
BRS 4002 (RF or (radio adj frequency)) and substrate and (dielectric near3 layer) and
((metal or conduct\$4) near3 (layer or film))
BRS 3346 ((RF or (radio adj frequency)) and substrate and (dielectric near3 layer)
and ((metal or conduct\$4) near3 (layer or film))) and (spiral or circ\$5)
BRS 1009 ((RF or (radio adj frequency)) and substrate and (dielectric near3 layer)
and ((metal or conduct\$4) near3 (layer or film))) and (spiral or circular)
BRS 1 "5541442".PN.
BRS 1 "5446311".PN.
BRS 1 "5095357".PN.
BRS 1 "5384274".PN.
BRS 1 "5268315".PN.
BRS 1 "5174012".PN.
BRS 1 "5753949".PN.
BRS 1 "5583359".PN.
BRS 307 (RF or (radio adj frequency)) and substrate and (dielectric) and ((metal or
conduct\$4) same ((via or feedthrough) and inductor))
BRS 473 257/531
BRS 1667 257/532
BRS 221 257/534
BRS 206 257/535
BRS 265 257/621